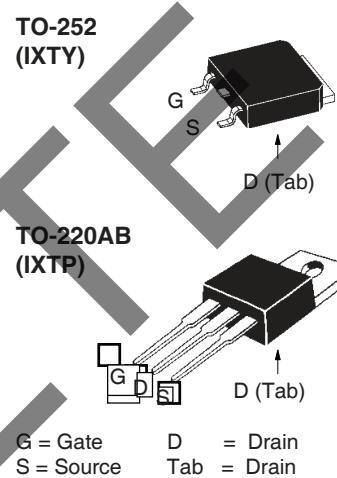
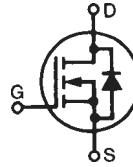


**Polar™**  
**Power MOSFET**

**IXTY1R6N50P**  
**IXTP1R6N50P**

**V<sub>DSS</sub>** = 500V  
**I<sub>D25</sub>** = 1.6A  
**R<sub>DS(on)</sub>** ≤ 6.5Ω

N-Channel Enhancement Mode  
Avalanche Rated  
Fast Intrinsic Rectifier



Symbol	Test Conditions	Maximum Ratings		
V <sub>DSS</sub>	T <sub>J</sub> = 25°C to 150°C	500		V
V <sub>DGR</sub>	T <sub>J</sub> = 25°C to 150°C, R <sub>GS</sub> = 1MΩ	500		V
V <sub>GSS</sub>	Continuous	±30		V
V <sub>GSM</sub>	Transient	±40		V
I <sub>D25</sub>	T <sub>C</sub> = 25°C	1.6		A
I <sub>DM</sub>	T <sub>C</sub> = 25°C, Pulse Width Limited by T <sub>JM</sub>	2.5		A
I <sub>A</sub>	T <sub>C</sub> = 25°C	1.6		A
E <sub>AS</sub>	T <sub>C</sub> = 25°C	75		mJ
dv/dt	I <sub>S</sub> ≤ I <sub>DM</sub> , V <sub>DD</sub> ≤ V <sub>DSS</sub> , T <sub>J</sub> ≤ 150°C	10		V/ns
P <sub>D</sub>	T <sub>C</sub> = 25°C	43		W
T <sub>J</sub>		-55 ... +150		°C
T <sub>JM</sub>		150		°C
T <sub>stg</sub>		-55 ... +150		°C
T <sub>L</sub>	Maximum Lead Temperature for Soldering	300		°C
T <sub>SOLD</sub>	1.6 mm (0.062in.) from Case for 10s	260		°C
F <sub>c</sub>	Mounting Force (TO-263)	10.65 / 2.2..14.6		N/lb
M <sub>d</sub>	Mounting Torque (TO-220)	1.13 / 10		Nm/lb.in
Weight	TO-252	0.35		g
	TO-220	3.00		g

Symbol	Test Conditions (T <sub>J</sub> = 25°C Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
BV <sub>DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA	500		V
V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 25μA	3.0		V
I <sub>GSS</sub>	V <sub>GS</sub> = ± 20V, V <sub>DS</sub> = 0V			±50 nA
I <sub>DSS</sub>	V <sub>DS</sub> = V <sub>DSS</sub> , V <sub>GS</sub> = 0V		1 μA	
	T <sub>J</sub> = 125°C		50 μA	
R <sub>DS(on)</sub>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 0.5 • I <sub>D25</sub> , Notes 1, 2		6.5	Ω

#### Features

- International Standard Packages
- Low Q<sub>G</sub>
- Avalanche Rated
- Low Package Inductance
- Fast Intrinsic Rectifier

#### Advantages

- High Power Density
- Easy to Mount
- Space Savings

#### Applications

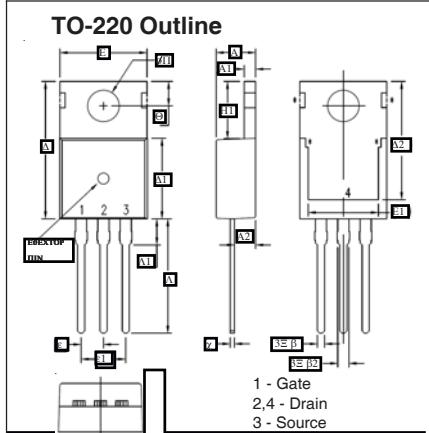
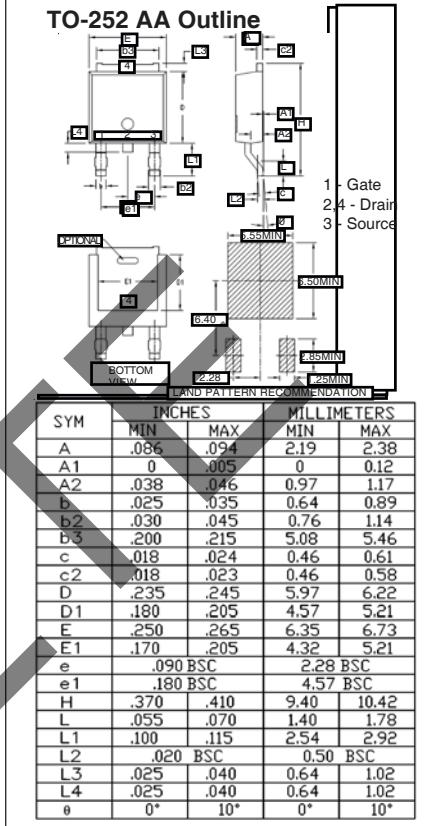
- DC-DC Converters
- Switch-Mode and Resonant-Mode Power Supplies
- AC and DC Motor Drives
- Discharge Circuits in Lasers, Spark Igniters, RF Generators
- High Voltage Pulse Power Applications

Symbol	Test Conditions ( $T_J = 25^\circ\text{C}$ , Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
$g_{fs}$	$V_{DS} = 20\text{V}$ , $I_D = 0.5 \cdot I_{D25}$ , Note 1	0.7	1.3	S
$C_{iss}$		140		pF
$C_{oss}$	$V_{GS} = 0\text{V}$ , $V_{DS} = 25\text{V}$ , $f = 1\text{MHz}$	20		pF
$C_{rss}$		2.6		pF
$t_{d(on)}$		20		ns
$t_r$	<b>Resistive Switching Times</b> $V_{GS} = 10\text{V}$ , $V_{DS} = 0.5 \cdot V_{DSS}$ , $I_D = 0.5 \cdot I_{D25}$	26		ns
$t_{d(off)}$		45		ns
$t_f$		23		ns
$Q_{g(on)}$		3.9		nc
$Q_{gs}$	$V_{GS} = 10\text{V}$ , $V_{DS} = 0.5 \cdot V_{DSS}$ , $I_D = 0.5 \cdot I_{D25}$	1.4		nc
$Q_{gd}$		1.3		nc
$R_{thJC}$			2.9	$^\circ\text{C}/\text{W}$
$R_{thCS}$	TO-220	0.50		$^\circ\text{C}/\text{W}$

### Source-Drain Diode

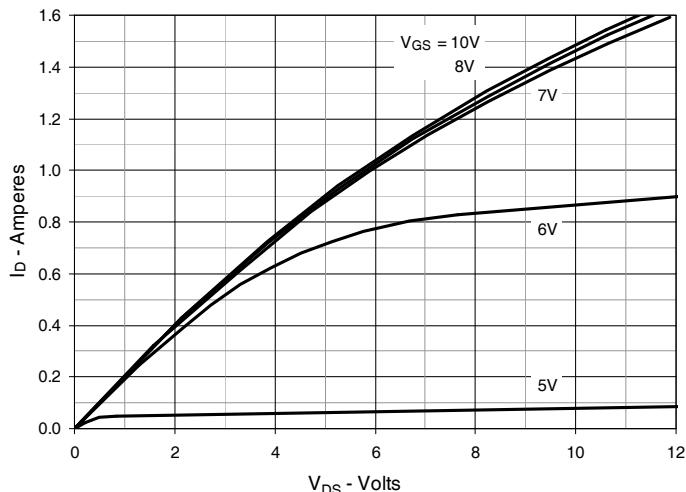
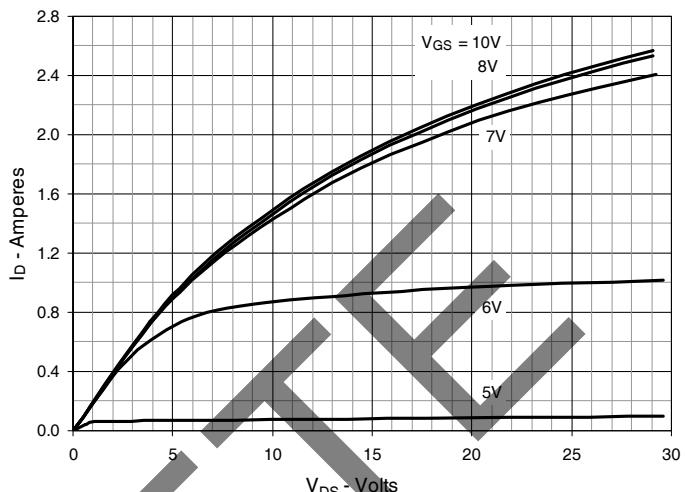
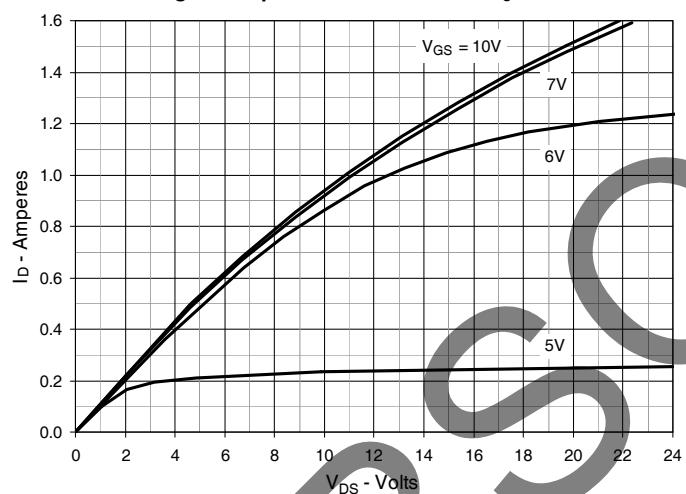
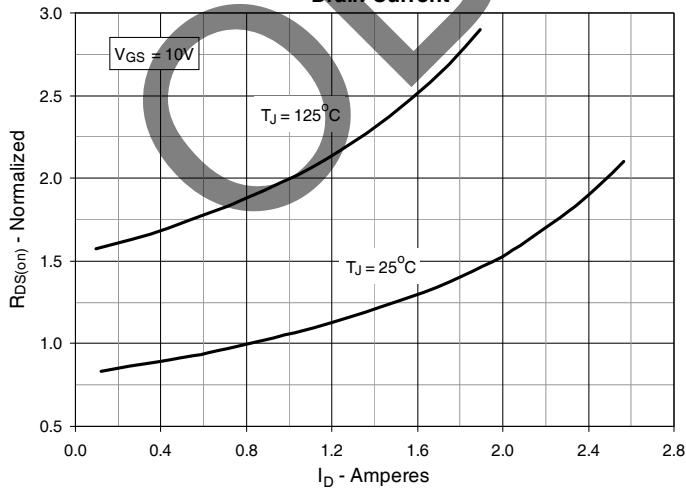
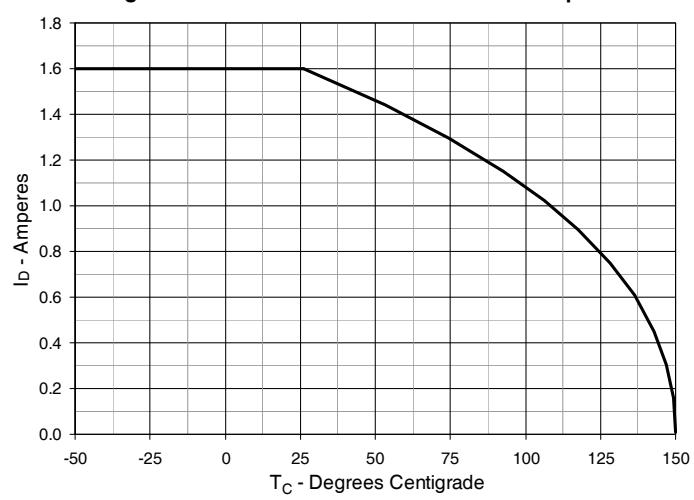
Symbol	Test Conditions ( $T_J = 25^\circ\text{C}$ , Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
$I_s$	$V_{GS} = 0\text{V}$		1.6	A
$I_{SM}$	Repetitive, Pulse Width Limited by $T_{JM}$		5.0	A
$V_{SD}$	$I_F = I_S$ , $V_{GS} = 0\text{V}$ , Note 1		1.5	V
$t_{rr}$	$I_F = 1.6\text{A}$ , $V_{GS} = 0\text{V}$ , $-di/dt = 100\text{A}/\mu\text{s}$ $V_R = 100\text{V}$	400		ns

Notes: 1. Pulse test,  $t \leq 300\mu\text{s}$ , duty cycle,  $d \leq 2\%$ .  
 2. On through-hole package,  $R_{DS(on)}$  Kelvin test contact location must be 5mm or less from the package body.

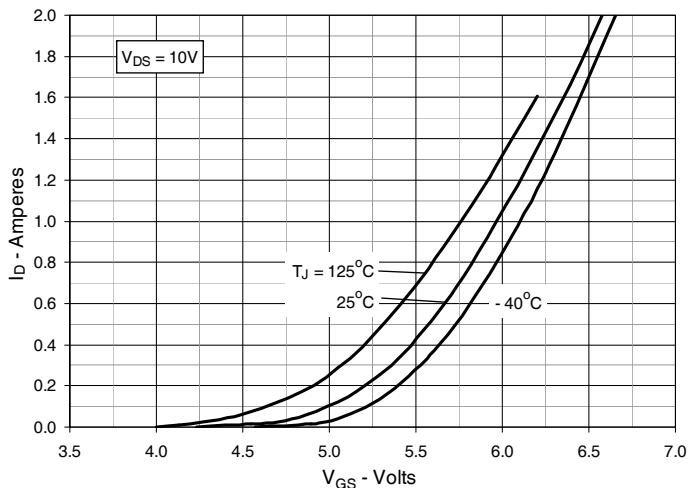


IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

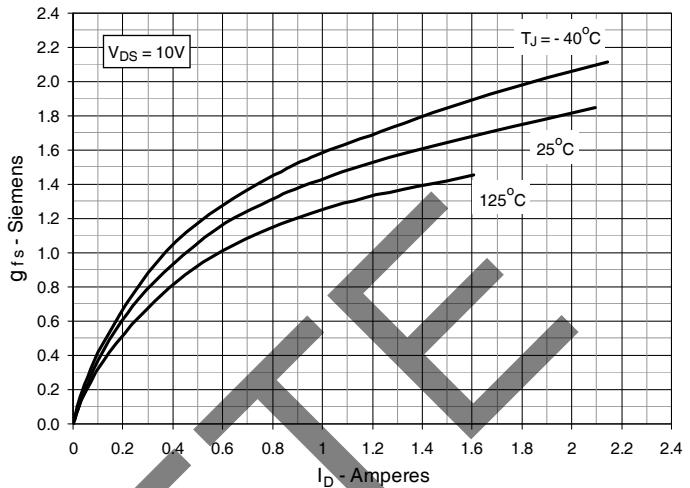
IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: 4,835,592 4,931,844 5,049,961 5,237,481 6,162,665 6,404,065 B1 6,683,344 6,727,585 7,005,734 B2 7,157,338B2 4,860,072 5,017,508 5,063,307 5,381,025 6,259,123 B1 6,534,343 6,710,405 B2 6,759,692 7,063,975 B2 4,881,106 5,034,796 5,187,117 5,486,715 6,306,728 B1 6,583,505 6,710,463 6,771,478 B2 7,071,537

**Fig. 1. Output Characteristics @  $T_J = 25^\circ\text{C}$** 

**Fig. 2. Extended Output Characteristics @  $T_J = 25^\circ\text{C}$** 

**Fig. 3. Output Characteristics @  $T_J = 125^\circ\text{C}$** 

**Fig. 5.  $R_{DS(on)}$  Normalized to  $I_D = 0.8A$  Value vs. Drain Current**

**Fig. 6. Maximum Drain Current vs. Case Temperature**


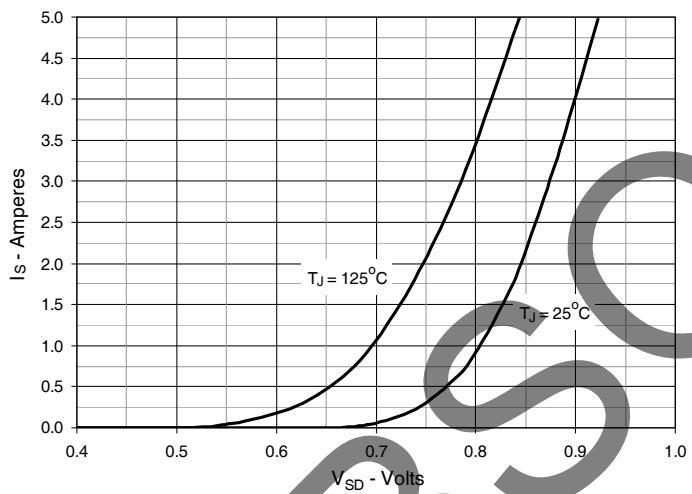
**Fig. 8. Input Admittance**



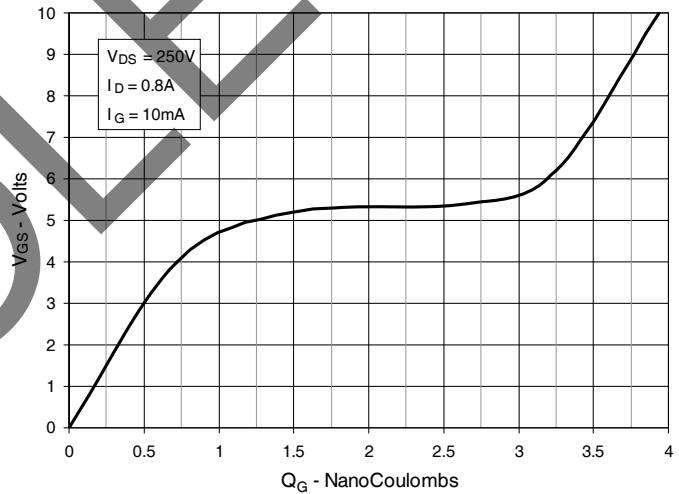
**Fig. 9. Transconductance**



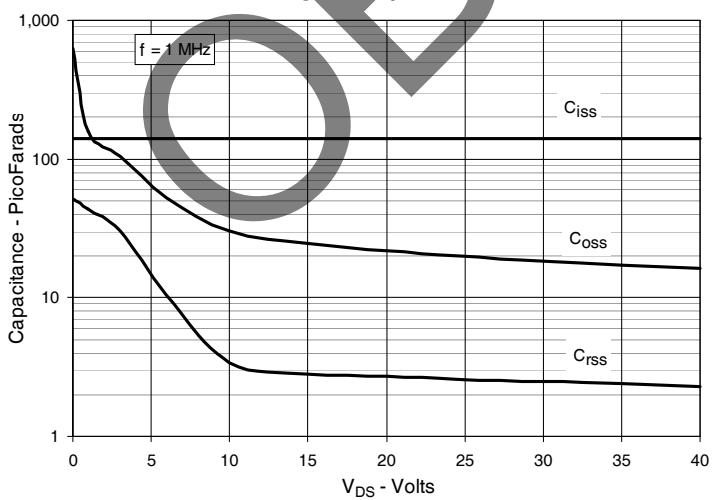
**Fig. 10. Forward Voltage Drop of Intrinsic Diode**



**Fig. 11. Gate Charge**



**Fig. 12. Capacitance**



**Fig. 14. Forward-Bias Safe Operating Area**

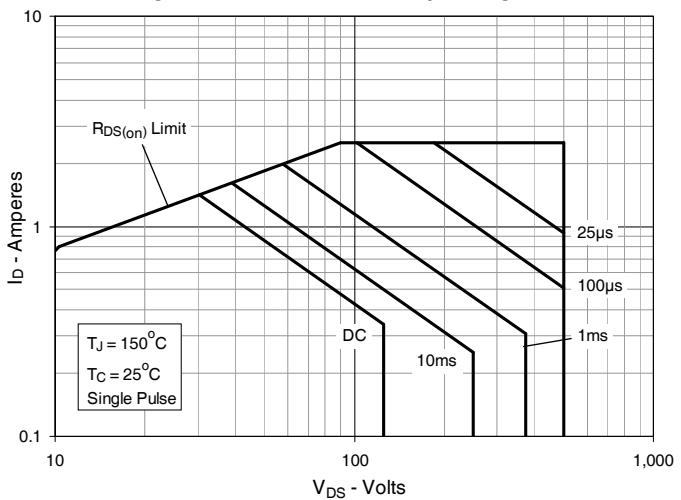


Fig. 13. Maximum Transient Thermal Impedance

